EUROPEAN PATENT OFFICE

Patent Abstracts of Japan

PUBLICATION NUMBER

01291401

PUBLICATION DATE

24-11-89

APPLICATION DATE

19-05-88

APPLICATION NUMBER

63120423

APPLICANT: FUJI ELELCTROCHEM CO LTD;

INVENTOR:

INOUE JUNICHI;

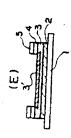
INT.CL.

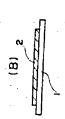
H01C 7/00 C23C 14/06 H01C 17/12

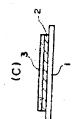
TITLE

THIN FILM RESISTOR AND

MANUFACTURE THEREOF







ABSTRACT :

PURPOSE: To obtain a thin film resistor whose temperature coefficient is almost zero and which enables reducing the equipment cost and the product manufacturing cost, by laminating a tantalum nitride film of a negative temperature coefficient and an $\alpha\text{-tantalum}$ film of a positive temperature coefficient on an alumina substrate, and by canceling both temperature coefficients each other out.

CONSTITUTION: A Ta_2N film 2 is formed on an alumina substrate 1, and an $\alpha\text{-Ta}$ film 3 of bcc structure is formed on this Ta₂N film 2. After that, electrodes comprising compound films of NiCr alloys 4 and Au 5 are attached to the $\alpha\textsc{-Ta}$ film 3. Then, they are heat-treated along with the electrodes in the atmosphere kept at 300°C, and a tantalum pentoxide film 3' is formed by oxidizing the surface of the part of the $\alpha\textsc{-}\textsc{Ta}$ film 3 where the electrodes are not attached. At this time, a part of them is connected with lead wires as a monitor to a resistance value measuring device outside of the heat-treating device, and they are simultaneously heat-treated until the temperature coefficient of the monitor becomes zero. In this way, a plurality of thin film resistors whose temperature coefficients are zero are obtained at the same time.

COPYRIGHT: (C)1989,JPO&Japio